Performance Enhancement of High Power High Repetition Rate Semiconductor Opening Switches

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High power semiconductor opening switches (SOSs) with $P^+PNN^+$ doping profile have been used in different pulsed power applications because of their fast high current interruption capability. In high pulsed power applications with high repetition rate, temperature increase of the semiconductor switch during its operation is no more negligible. In this paper, the cut-off characteristics of SOSs with different doping profiles are compared and then the impact of the temperature increase on the performance of the semiconductor opening switch is investigated using a detailed physical model. The simulation results indicate that due to the temperature increase of the switch, both the current amplitude and the cut-off characteristics of the switch are affected. Semiconductor opening switches with different base materials (Si and SiC) are studied. Due to favorable intrinsic characteristics of SiC (higher thermal conductivity, higher saturation velocity and higher breakdown electric field), the performance of the SOS can be enhanced using SiC as the base material and the design of compact high pulsed power applications can be achieved.

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1. Introduction

One of the main challenges in using inductive energy storage to generate high pulsed power is to design a switch capable of fast interruption of high currents and holding off high recovery voltages. Recently, due to high repetition rate and reliability, Semiconductor Opening Switches with a doping profile of $P^+PNN^+$ have been used in different pulsed power applications. In the present paper the impact of different doping profiles on the performance of SOS is investigated and then the influence of temperature increase due to high repetition rate on the performance of the switch is demonstrated. Eventually semiconductor opening switches with different base materials (Si and SiC) are studied.

2. Impact of varying diffusion length on the SOS performance

To investigate the influence of different doping profiles on the cut-off characteristics of SOS, the length of P-region ($x_p$) is changed from 100 $\mu$m to 200 $\mu$m (see Fig. 1). Physical model used here, which considers all relevant equations to simulate the interruption process at temperature $T = 300$ K, is based on [1]. The space charge along the device for different lengths of P-region and times has been shown in Fig. 1. The interruption process begins when the plasma distribution reaches its equilibrium level making a space charge region due to uncompensated charge carriers. As it can be seen, in all cases the current interruption begins from highly doped N-region and ends at highly doped P-region. With the growth of $x_p$ the extra plasma and consequently the current have been increased and cut-off time has been decreased (see Fig. 2). It can be seen that with the increase of $x_p$ the space charge is formed faster and with higher extent in two highly doped regions causing higher built-in electric field and faster current interruption.

Fig. 1. Doping profile of SOS and space charge formation for three lengths of P-region ($x_p$) and two time instants. The beginning of current interruption is considered to be $t = 0$.

Although the cut-off characteristics (interruption time and interrupted current) can be improved with the increase of $x_p$, the hold-off voltage characteristics of the switch is degraded. So, while varying $x_p$ one has to make a compromise between hold-off voltage and interruption characteristics.
3. Temperature increase in SOS

In high pulsed power applications with high repetition rate, the performance of the SOS is affected by the temperature increase in the device. In previous simulations, thermal effects have been neglected given that the SOS is dealing with a single pulse only [2]. To investigate the thermal and electrical behavior of the switch, a detailed physical model has been used which takes into account the effect of non-uniform temperature distribution on the electrical behavior of the device, as well as the temperature dependence of the recombination, electron/hole lifetimes, avalanche, mobility and intrinsic carrier concentration [3, 4]. The electrodes of the device are assumed as constant temperature boundaries. To numerically accelerate the impact of temperature rise on the device performance and reduce simulation time, a 10 MHz repetition rate has been selected in these simulations.

4. SiC-based SOS

Silicon carbide (SiC) is a very promising material for use in high power semiconductor devices. Many of the favourable transport parameters in SiC are related to the large band-gap, which is of the order of 3 eV and due to this large band gap the intrinsic carrier concentration is low [6].

To study the possible application of SiC as the base material of SOS the same simulation has been performed as the previous section and the result is shown in Fig. 3. As it can be observed, like Si-based SOS the amplitude of the current interrupted has varied with the temperature rise in the device but for the same pulse number, in the SiC-based device the variation of the current amplitude and temperature with increase of pulse number is less than that of the Si-based SOS. The reason is that the thermal conductivity of SiC is more than three times higher than that of Si, which allows better heat dissipation and consequently the current and temperature sensitivity to the rise of pulse number is decreased. So one can expect that the deviation of the output voltage from nominal value is less in SOS based on SiC than Si-based device and the cooling system used becomes simpler.

Further improvement of the device performance can be made by increasing the doping level in SiC-based switch. As critical electric field in SiC is about ten times higher than that of Si, for a given hold-off voltage, doping level (N_d) in SiC-based device can be highly increased which according to \( j_r = qN_dV_s \) (\( j_r \) and \( V_s \) are current density and free carriers saturation velocity respectively) leads to higher interrupted current. Thus, favourable characteristics of SiC, i.e. high thermal conductivity, high critical electric field and high current density, result in compact design of high pulsed power high repetition rate devices.

5. Conclusions

It was shown that with the increase of \( x_p \) the cut-off characteristics of SOS are improved, at the expense of decrease in hold-off voltage. Also it was concluded that temperature rise in Si-based SOS leads to high variation of interrupted current and output voltage. To decrease these variations, a SiC-based SOS was studied. It was stated that the mentioned characteristics of SiC can lead to better performance of device and the design of more compact applications will be possible.
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References


